

Common mode filters

High-speed differential signal line (MIPI D-PHY, USB2.0, etc.)

TCM-M series



TCM0605M type



FEATURES

- Thin-film common mode filter based on the thin-film processing techniques and material technology cultivated from HDD head manufacturing.
- By optimizing the design, the signal transmission speed can be broadened (cutoff frequency of 4.8GHz or more) while also exerting a large noise suppression effect.
- This is the compact 0605 size (0.65x0.50x0.30mm) type.
- Operating temperature range: -25 to +85°C

APPLICATION

- Noise countermeasure for ultra-high-speed differential interfaces (MIPI-D PHY, USB2.0, HDMI, etc.) for mobile devices and general consumer products such as smart phones, tablets, digital cameras, and portable music players.
- Application guides: [Smart phones/tablets](#)

PART NUMBER CONSTRUCTION

TCM	0605	M	-	900	-	2P	-	T	201
Series name	LxWxT dimensions 0.65x0.5x0.3 mm	Product internal code		Impedance (Ω) at 100MHz		Number of lines		Packaging style	Internal code

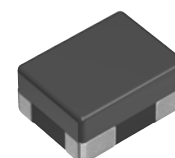
CHARACTERISTICS SPECIFICATION TABLE

Common mode attenuation (dB)	Common mode impedance [at 100MHz]	DC resistance [1 line] (Ω)	Cutoff frequency (GHz)	Rated current (A)max.	Rated voltage (V)max.	Insulation resistance (MΩ)min.	Part No.
24.0 dB min. @ 700M to 850MHz	105 typ.	2.6±30%	5.0 typ.	0.1	10	10	TCM0605M-900-2P-T201
24.0 dB min. @ 850M to 1.0GHz							
12.0 dB min. @ 1.0G to 2.0GHz							
22.0 dB min. @ 700M to 850MHz	80 typ.	2.6±30%	4.8 typ.	0.1	10	10	TCM0605M-650-2P-T201
26.0 dB min. @ 850M to 1.0GHz							
14.0 dB min. @ 1.0G to 2.0GHz							

Measurement equipment

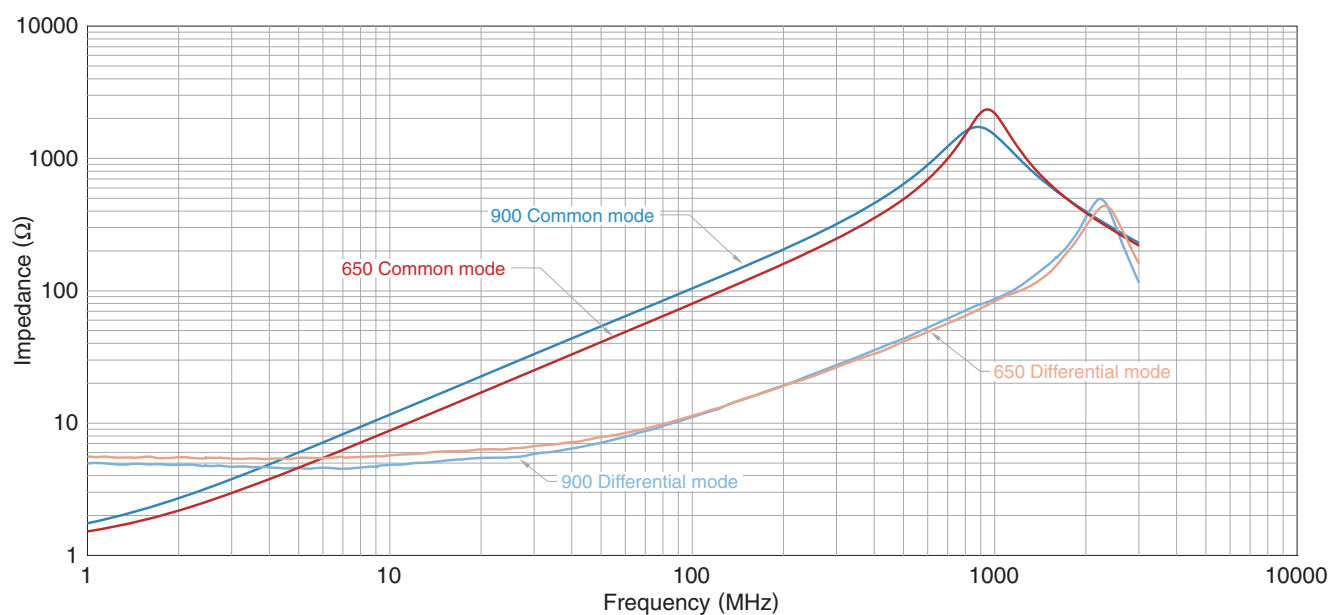
Measurement item	Product No.	Manufacturer
Common mode impedance	4291A	Keysight Technologies
DC resistance	4338A	Keysight Technologies
Insulation resistance	4339A	Keysight Technologies

* Equivalent measurement equipment may be used.



TCM0605M type

■ IMPEDANCE VS. FREQUENCY CHARACTERISTICS

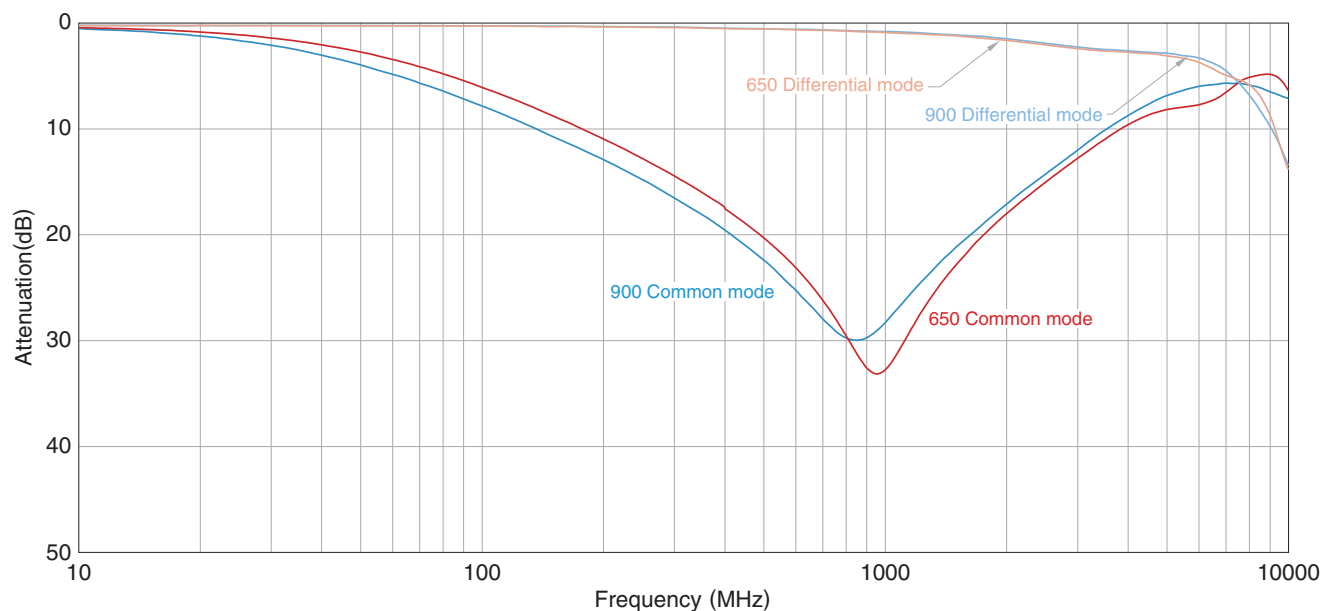


Measurement equipment

Product No.	Manufacturer
4991A	Keysight Technologies

* Equivalent measurement equipment may be used.

■ INSERTION LOSS VS. FREQUENCY CHARACTERISTICS



Measurement equipment

Product No.	Manufacturer
E5071B	Keysight Technologies

* Equivalent measurement equipment may be used.

■ SHAPE & DIMENSIONS



Dimensions in mm

• No polarity

The graph illustrates the temperature profile for a soldering process. The Y-axis represents Temperature, and the X-axis represents Time. The process is divided into three main stages:

- Preheating:** The temperature rises from 150°C to 180°C. This stage is labeled "Preheating" and has a duration of "60 to 120s".
- Soldering:** The temperature rises from 180°C to a peak of 245°C. This stage is labeled "Soldering" and has a duration of "10 to 30s". The peak is labeled "Peak" and "245°C". The time spent at the peak is labeled "5s max.".
- Natural cooling:** The temperature falls from 245°C to 230°C. This stage is labeled "Natural cooling".

Key temperature points and transitions are marked: 150°C, 180°C, 230°C, and 245°C.

REEL DIMENSIONS

[illegible]

Dimensions in mm

Package quantity	10000 pcs/reel
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Operating temperature range*	Storage temperature range**	Individual weight
-25 to +85 °C	-25 to +85 °C	0.5 mg

* Operating temperature range includes self-heating.

** The storage temperature range is for after the assembly.

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

REMINDERS

- The storage period is less than 6 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH or less).
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.
The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.
A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.
The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.
If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.

- (1) Aerospace/aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.